

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



#### Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







# HI2220R151R-10

## UNCONTROLLED DOCUMENT

#### PHYSICAL DIMENSIONS:

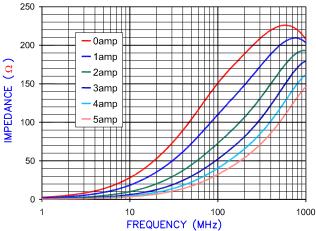
A 5.59 [.220] ± 0.51 [.020]

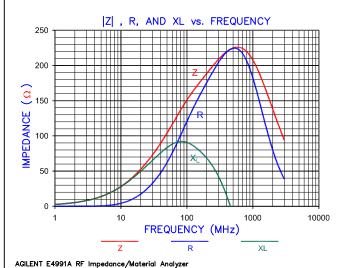
B 5.08 [.200] ± 0.25 [.010]

C 1.80 [.071] ± 0.25 [.010]

D 0.76 [.030] ± 0.25 [.010]

### Z vs. FREQUENCY IMPEDANCE UNDER DC BIAS





HP 16092A Test Fixture. TEST REF. 3185

A B N 1.

ELECT	ELECTRICAL CHARACTERISTICS:									
Z @ 100M ( Ω )	1Hz	DCR (Ω)	Rated Current							
Nominal	150									
Minimum	113									
Maximum	187	0.015	5000 mA							

NOTES: UNLESS OTHERWISE SPECIFIED

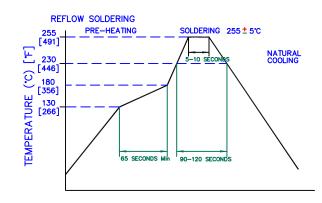
- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 13" REELS, 2,000 PCS/REEL.
- 2. TERMINATION FINISH IS 100% TIN.
- 3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 4. OPERATEING TEMPERATURE TEMP: -40°C~+125°C (INCLUDING SELF-HEATING)

#### LAND PATTERNS FOR REFLOW SOLDERING

### 3.05 [.120] 6.10 [.240] 9.19 [.362]

(For wave soldering, add 0.762 [.030] to this dimension)

#### RECOMMENDED SOLDERING CONDITIONS



F		DIMENSIONS ARE IN mm [INCHE	:s].		This print is the property of Laird Tech. and is loaned in confidence				
					subject to return upon request an with the understanding that no copies shall be made without the written consent of Laird Tech. All rights to design or invention are reserved.	nd L	a		
L					PROJECT/PART NUMBER:	REV	PART TO	PE:	DRAWN BY:
	С	ADD OPERATING TEMPERATURE UPDATE LAIRD LOGO AND REFLOW CURVE	08/05/13	QU	HI2220R151R-10	С	CO-	-FIRE	тмв
Ī	В	UPDATE COMPANY LOGO ADD ROHS	01/25/08	JRK	DATE: 04/03/04 SC	ÀLE: N	E: NTS		
Γ	Α	ORIGINAL DRAFT	04/03/04	ТМВ	CAD #	OL #	13	2	of 2
Ī	REV	DESCRIPTION	DATE	INT	HI2220R151R-10-C	_			01 2

